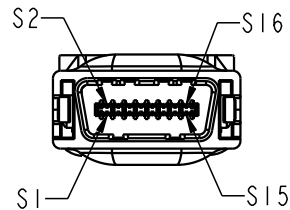
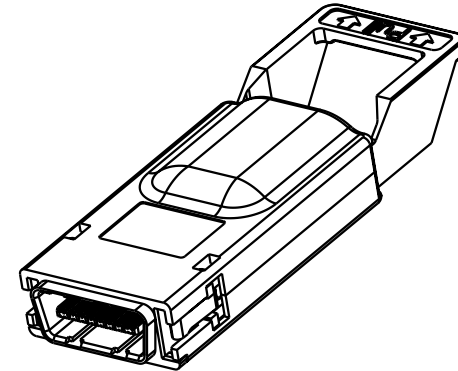
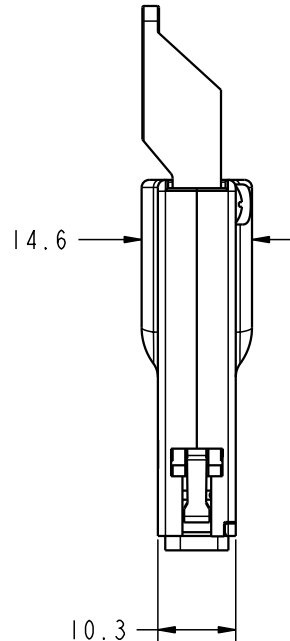
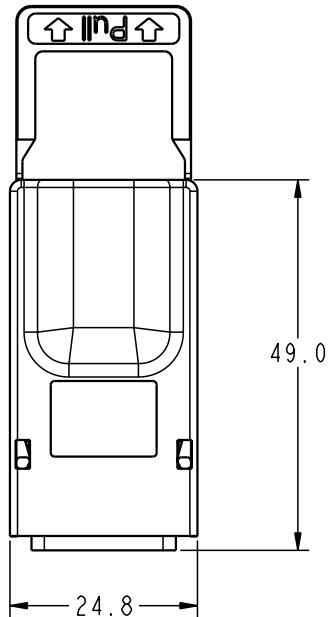


PRODUCT NO.
10010263-001
10010263-001LF



### PIN CONNECTIONS

FROM		TO	
PIN NO.	SIGNAL	PIN NO.	SIGNAL
S1	IBtxIp(0)	S16	IBtxOp(0)
S2	IBtxIn(0)	S15	IBtxOn(0)
S3	IBtxIp(1)	S14	IBtxOp(1)
S4	IBtxIn(1)	S13	IBtxOn(1)
S5	IBtxIp(2)	S12	IBtxOp(2)
S6	IBtxIn(2)	S11	IBtxOn(2)
S7	IBtxIp(3)	S10	IBtxOp(3)
S8	IBtxIn(3)	S9	IBtxOn(3)

rev	ecn no	dr	date
C	CY21256	PC	11/22/02
D	CY31359	NHL	03/29/03
E	CY03-1444	GL	06/16/03
F	V03-1234	DAI	12/03/03
G	V04-0483	DAI	06/17/04
H	V05-0064	TAB	03/07/05
J	V05-0542	TAB	06/17/05

TOLERANCES UNLESS OTHERWISE SPECIFIED			
LINEAR	0.X	±.3	
	0.XX	±.10	
	0.XXX	±.050	
ANGULAR	0°	±2°	

### NOTES:

- MATES WITH FCI RECEPTACLES 58368 OR 58369.
- MATERIALS:  
BLOCKER - ALUMINUM ALLOY  
BACKSHELL - ZINC ALLOY, NICKEL PLATING OVER COPPER  
CONNECTOR - THERMOPLASTIC AND COPPER ALLOY  
LATCH - THERMOPLASTIC AND STAINLESS STEEL  
PRINTED CIRCUIT BOARD - FR4 FIBERGLASS
- PRODUCT SPECIFICATION: GS-12-209.
- LEAD FREE SOLDER TAIL PLATING 2μm(80μin) MIN MATTE TIN OVER 1.27μm(50μin) MIN NICKEL UNDERPLATE.
- IF LEAD FREE PART NUMBER, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MIN THICK CIRCUIT BOARD.
- PACKAGING OF LEAD FREE PRODUCTS MEETS LABELING AND PACKAGING SPECIFICATION GS-14-920.
- LEAD FREE PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

<b>FCI</b>		www.fciconnect.com		surface <input checked="" type="checkbox"/> ASME Y14.5	tolerance ASME Y14.5	projection	MM
Dr	P.C.	N.LEE	Product family	EYEMAX(tm)	size	A4	Scale 1:1
Eng	N.LEE	07/09/02	Spec ref	-	ECN	V05-0542	
Chr	PC	07/09/02	Material	SEE NOTES			
Appr	N.LEE	07/09/02					
title 4X EYEMAX LOOPBACK MODULE					dwg no	10010263	Rev. J
catalog no					CUSTOMER sheet 1 of 1		